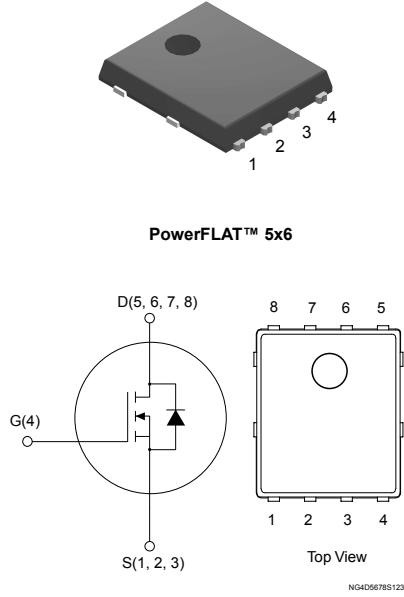


Automotive-grade 40 V, 7.0 mΩ typ., 64 A, STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

Features



Order code	V _{DS}	R _{DS(on)} max.	I _D
STL64N4F7AG	40 V	8.5 mΩ	64 A

- AEC-Q101 qualified 
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

Applications

- Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low on-state resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Product status link	
STL64N4F7AG	
Product summary	
Order code	STL64N4F7AG
Marking	64N4F7
Package	PowerFLAT™ 5x6
Packing	Tape and reel

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	40	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current (continuous) at $T_C = 25^\circ\text{C}$	64	A
	Drain current (continuous) at $T_C = 100^\circ\text{C}$	40.3	A
$I_{DM}^{(1)}$	Drain current (pulsed)	256	A
P_{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$	65	W
T_j	Operating junction temperature range	-55 to 175	$^\circ\text{C}$
T_{stg}	Storage temperature range		

1. Pulse width limited by safe operating area

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb	32	$^\circ\text{C/W}$
$R_{thj-case}$	Thermal resistance junction-case	2.3	$^\circ\text{C/W}$

1. When mounted on FR-4 board of 1 inch², 2oz Cu, $t < 10$ s.

2 Electrical characteristics

($T_C = 25^\circ\text{C}$ unless otherwise specified)

Table 3. On-/off-states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	40			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 40 \text{ V}$			1	μA
I_{GSS}	Gate-body leakage current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2		4	V
$R_{\text{DS(on)}}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 32 \text{ A}$		7.0	8.5	$\text{m}\Omega$

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	637	-	pF
C_{oss}	Output capacitance		-	240	-	pF
C_{rss}	Reverse transfer capacitance		-	26	-	pF
Q_g	Total gate charge	$V_{DD} = 20 \text{ V}, I_D = 64 \text{ A},$	-	9.8	-	nC
Q_{gs}	Gate-source charge	$V_{GS} = 0 \text{ to } 10 \text{ V}$	-	3.8	-	nC
Q_{gd}	Gate-drain charge	(see Figure 13. Test circuit for gate charge behavior)	-	3.1	-	nC

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(\text{on})}$	Turn-on delay time	$V_{DD} = 20 \text{ V}, I_D = 32 \text{ A},$	-	18.8	-	ns
t_r	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	102.6	-	ns
$t_{d(\text{off})}$	Turn-off delay time	(see Figure 12. Test circuit for resistive load switching times and Figure 17. Switching time waveform)	-	21.4	-	ns
t_f	Fall time		-	13.3	-	ns

Table 6. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{SD}^{(1)}$	Forward on voltage	$I_{SD} = 64 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.3	V
t_{rr}	Reverse recovery time	$I_D = 64 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$	-	27.5		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 32 \text{ V}$ (see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	17.3		nC
I_{RRM}	Reverse recovery current		-	1.4		A

1. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1

Electrical characteristics (curves)

Figure 1. Safe operating area

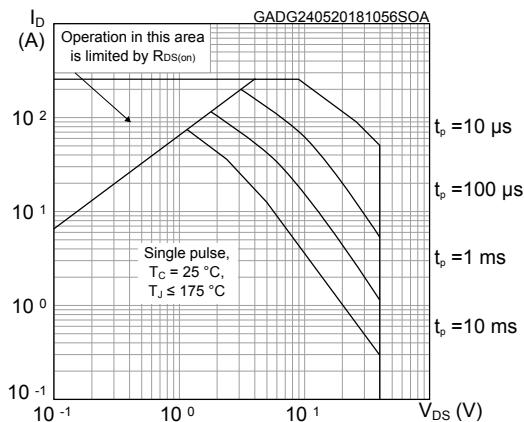


Figure 2. Thermal impedance

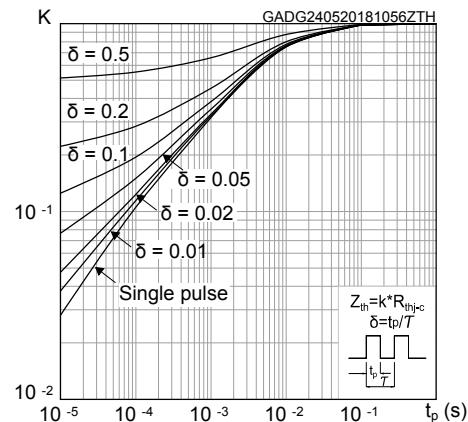


Figure 3. Output characteristics

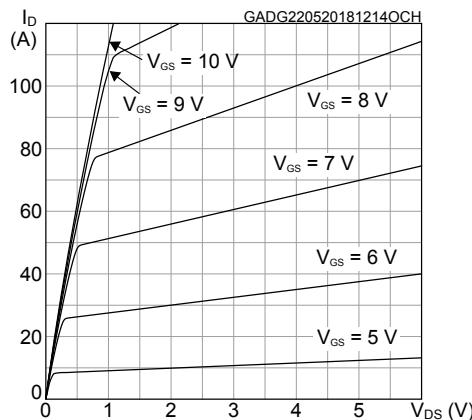


Figure 4. Transfer characteristics

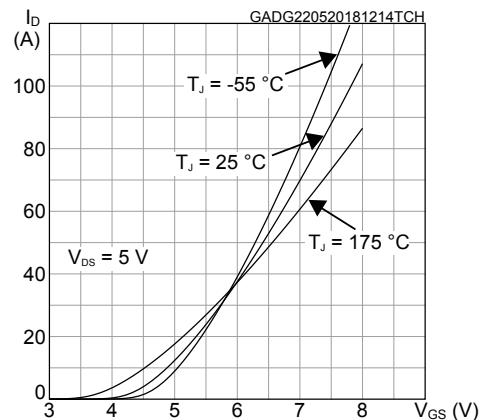


Figure 5. Gate charge vs gate-source voltage

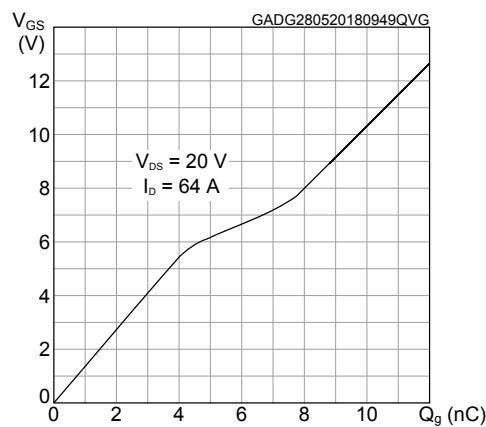


Figure 6. Static drain-source on-resistance

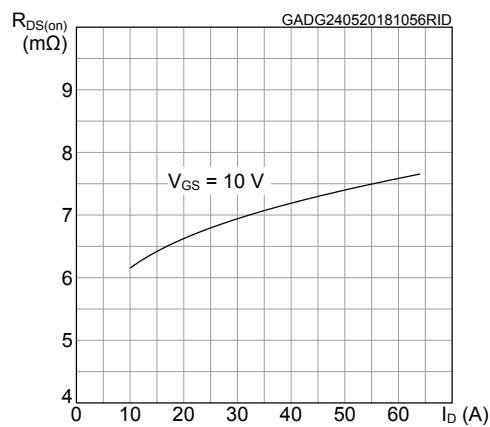
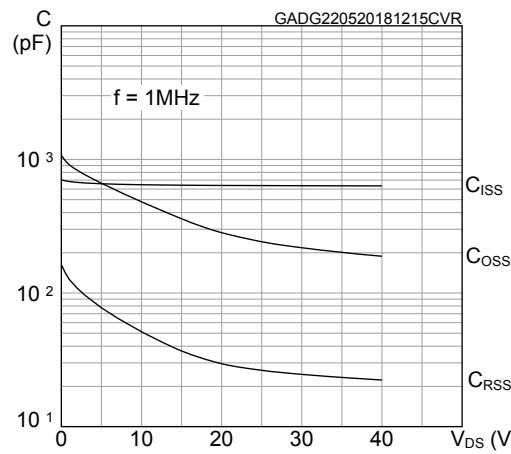
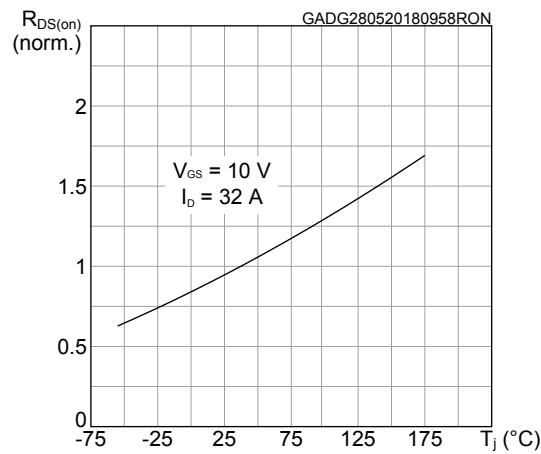
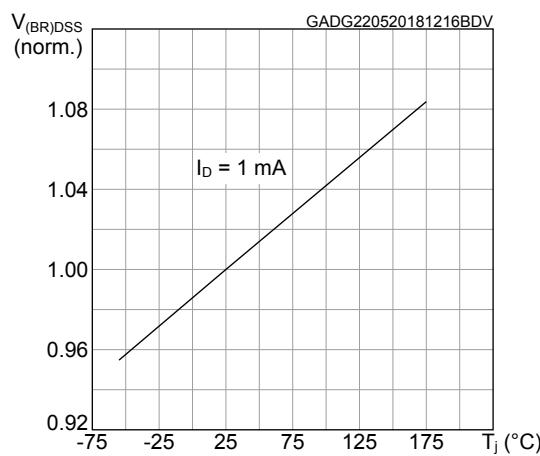
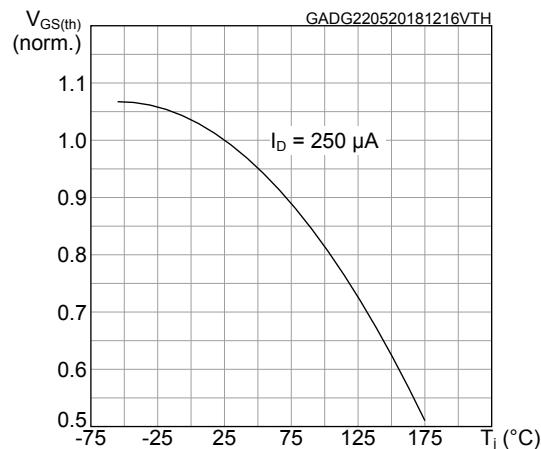
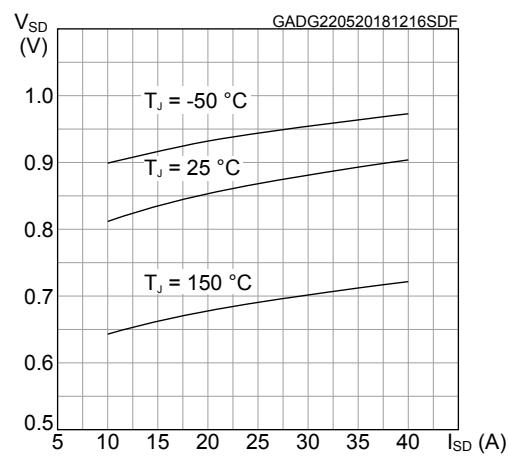
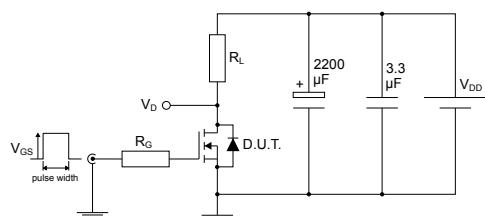


Figure 7. Capacitance variations

Figure 8. Normalized on-resistance vs temperature

Figure 9. Normalized $V_{(BR)DSS}$ vs temperature

Figure 10. Normalized gate-threshold voltage vs temperature

Figure 11. Source-drain diode forward characteristics


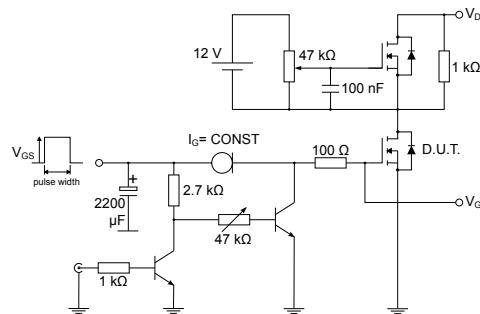
3 Test circuits

Figure 12. Test circuit for resistive load switching times



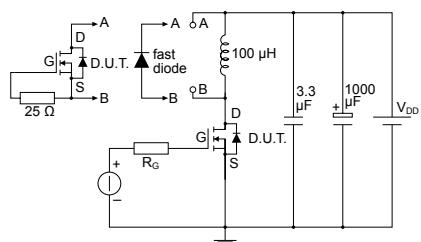
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Figure 13. Test circuit for gate charge behavior



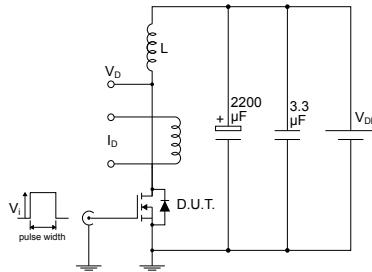
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Figure 14. Test circuit for inductive load switching and diode recovery times



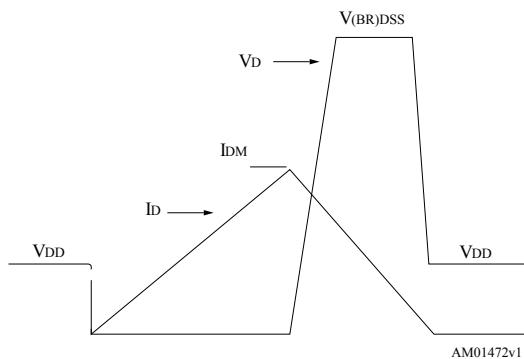
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Figure 15. Unclamped inductive load test circuit



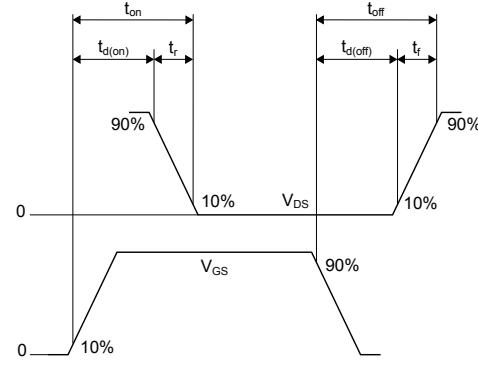
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Figure 16. Unclamped inductive waveform



AM01472v1

Figure 17. Switching time waveform



AM01473v1

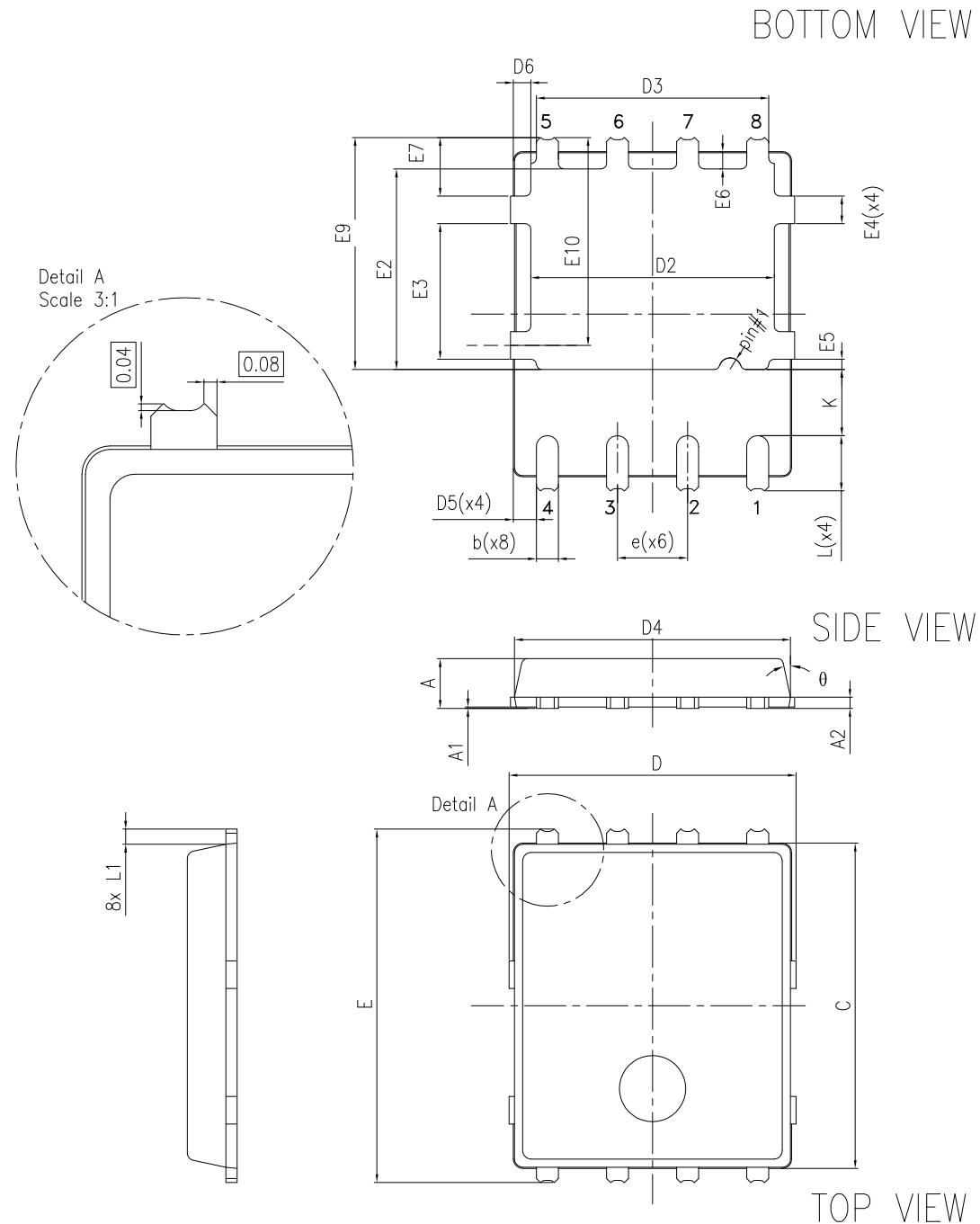
4

Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 PowerFLAT™ 5x6 WF type C package information

Figure 18. PowerFLAT™ 5x6 WF type C package outline

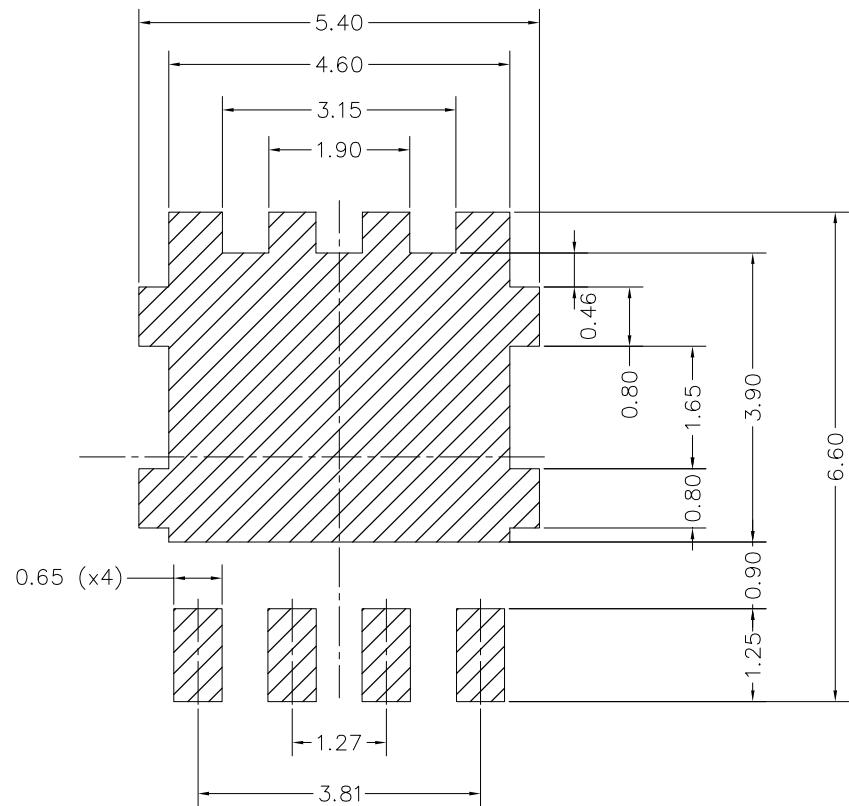


8231817_WF_typeC_r16

Table 7. PowerFLAT™ 5x6 WF type C mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
C	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
e		1.27	
E	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
K	1.05		1.35
L	0.90	1.00	1.10
L1	0.175	0.275	0.375
θ	0°		12°

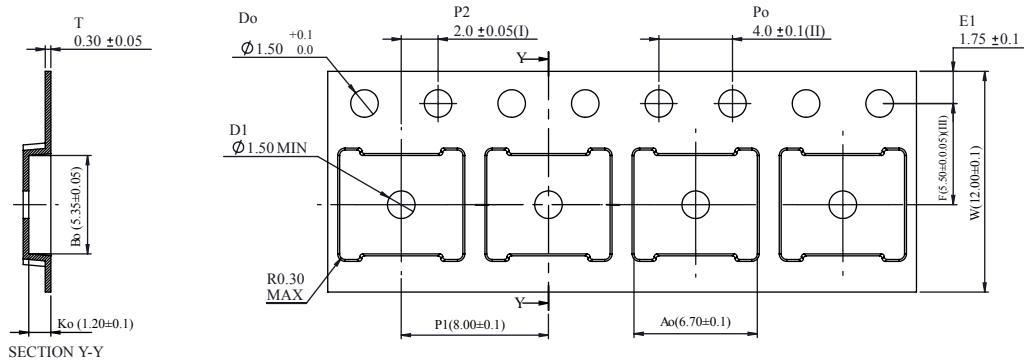
Figure 19. PowerFLAT™ 5x6 recommended footprint (dimensions are in mm)



8231817_FOOTPRINT_rev16

4.2 PowerFLAT™ 5x6 WF packing information

Figure 20. PowerFLAT™ 5x6 WF tape (dimensions are in mm)



- (I) Measured from centreline of sprocket hole to centreline of pocket.
- (II) Cumulative tolerance of 10 sprocket holes is ± 0.20 .
- (III) Measured from centreline of sprocket hole to centreline of pocket.

Base and bulk quantity 3000 pcs

8234350_TapeWF_rev_C

Figure 21. PowerFLAT™ 5x6 package orientation in carrier tape

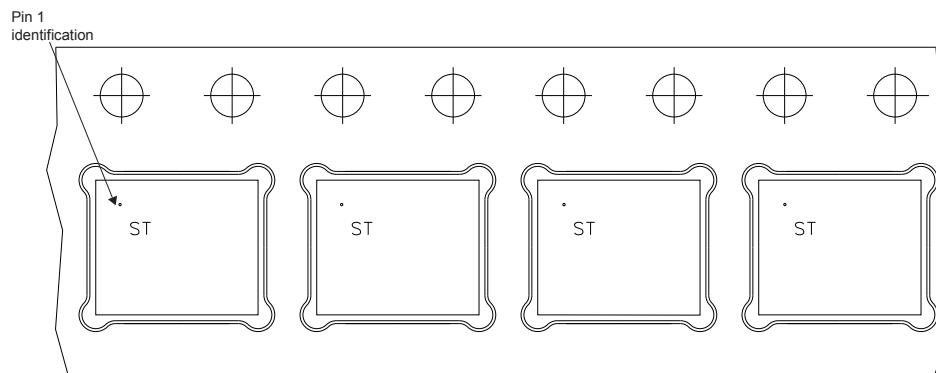
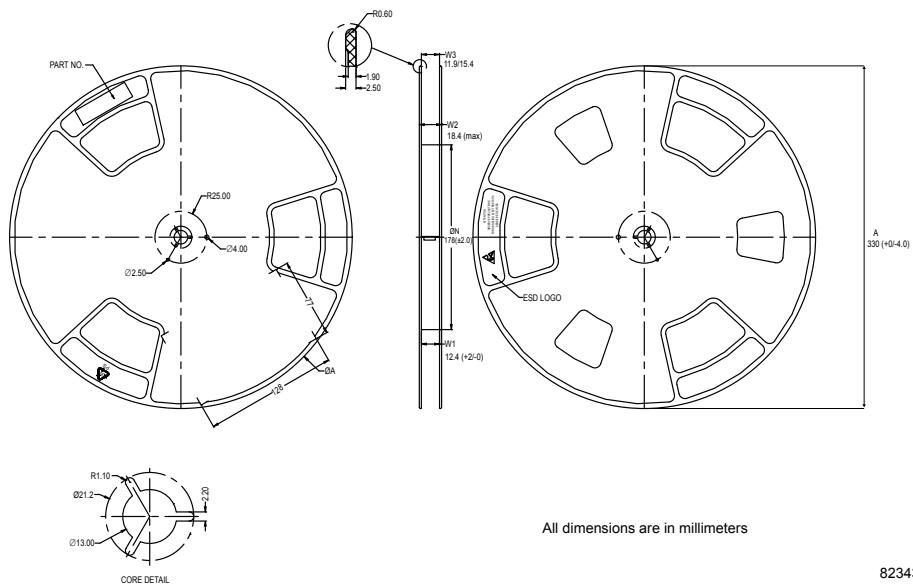


Figure 22. PowerFLAT™ 5x6 reel (dimensions are in mm)



All dimensions are in millimeters

8234350_Reel_rev_C

Revision history

Table 8. Document revision history

Date	Version	Changes
30-May-2018	1	Initial release
27-Jun-2018	2	Updated title and features in cover page.

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